# DATA SHEET

Part No.	AN15853AA
Package Code No.	SSOP036-P-0450C

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**Panasonic** 

# AN15853AA

### 4-Input AV Switch IC

#### ■ Applications

• For color TV

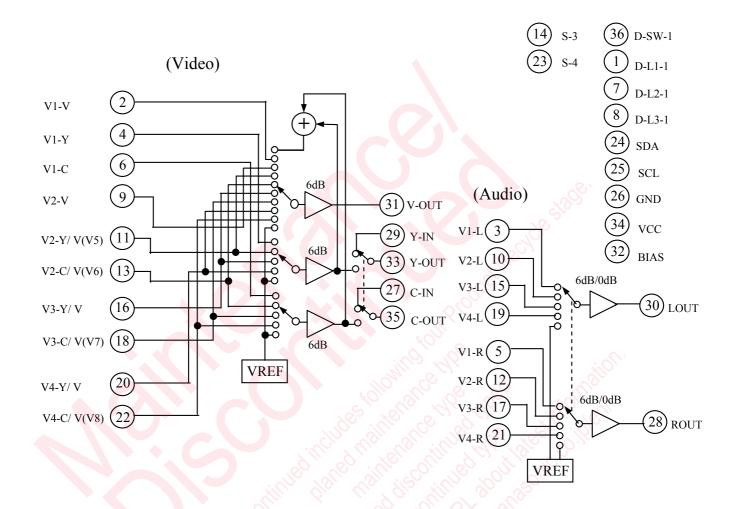
#### ■ Package

• 36-pin Plastic Shrink Small Outline Package (SSOP Type)

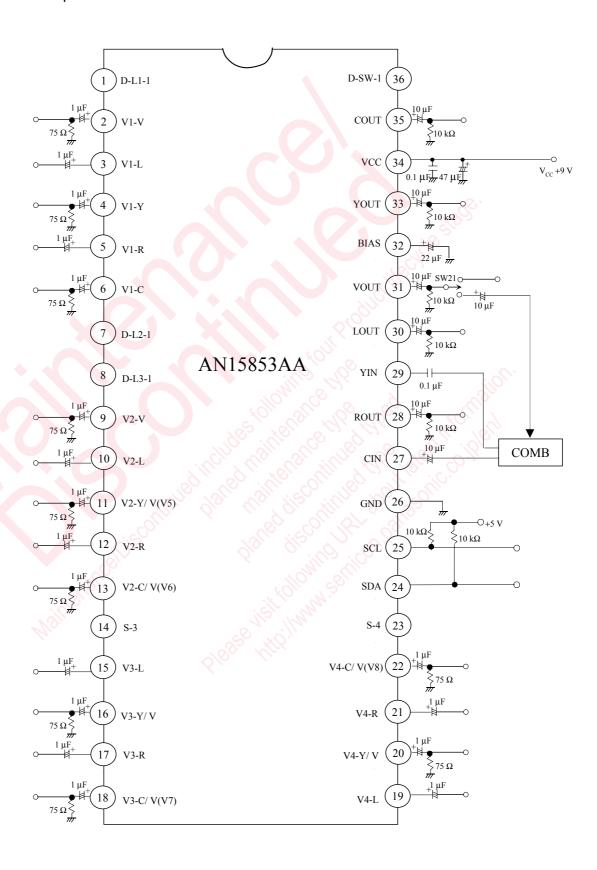
#### ■ Type

• Silicon monolithic bipolar IC

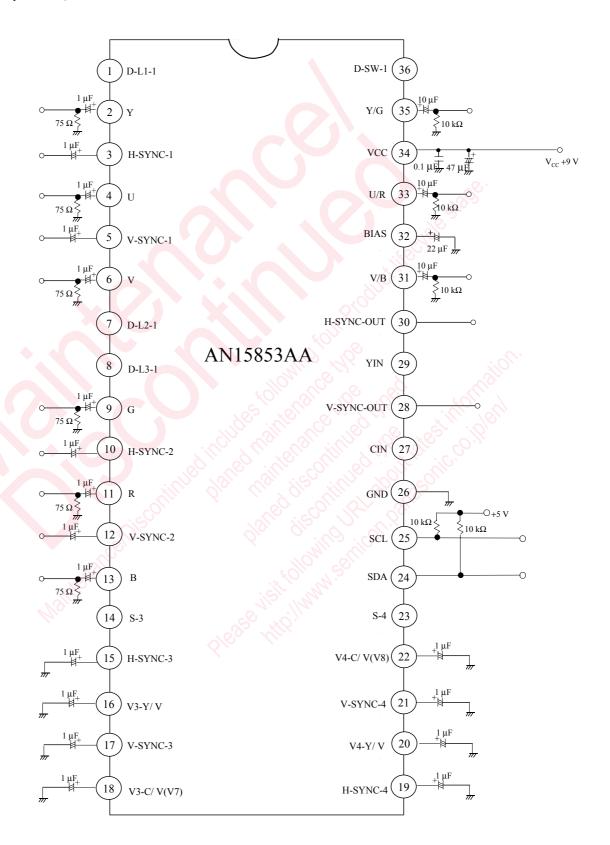
#### ■ Block Diagram



#### ■ Application Circuit Example



## ■ Application Circuit Example (continued) (For H/V SYNC Input Select)



#### ■ Pin Descriptions

Pin No.	端子名	Pin No.	端子名	Pin No.	端子名
1	D-L1-1	13	V2-C/ V(V6) Input	25	SCL
2	V1-V Input	14	S-3 Input	26	GND
3	V1-L Input	15	V3-L Input	27	CIN
4	V1-Y Input	16	V3-Y/ V Input	28	ROUT
5	V1-R Input	17	V3-R Input	29	YIN
6	V1-C Input	18	V3-C/ V(V7) Input	30	LOUT
7	D-L2-1	19	V4-L Input	31	VOUT
8	D-L3-1	20	V4-Y/ V Input	32	BIAS
9	V2-V Input	21	V4-R Input	33	YOUT
10	V2-L Input	22	V4-C/ V(V8) Input	34	VCC
11	V2-Y/ V(V5) Input	23	S-4	35	COUT
12	V2-R Input	24	SDA	36	D-SW-1

#### ■ Absolute Maximum Ratings

A No.	Parameter	Symbol	Rating	Unit	Note
1	Storage temperature	$T_{\rm stg}$	-55 to +150	°C	*1
2	Operating ambient temperature	Topr	-20 to +70	°C	*1
3	Operating ambient atmospheric pressure	P <sub>opr</sub>	$1.013 \times 10^5 \pm 0.61 \times 10^5$	P <sub>a</sub>	
4	Operating constant gravity	$G_{opr}$	9 810	m/s <sup>2</sup>	
5	Operating shock	$S_{opr}$	4 900	m/s <sup>2</sup>	
6	Supply voltage	V <sub>CC</sub>	14	V	*2
7	Supply current	$I_{CC}$	60	mA	*2
8	Power dissipation	$P_{\mathrm{D}}$	642	mW	*3

Note) \*1: Except for the power dissipation, operating ambient temperature, and storage temperature, all ratings are for  $T_a = 25$ °C.

#### ■ Operating Supply Voltage Range

Parameter	Symbol	Range	Unit	Note
Supply voltage range	V <sub>CC</sub>	8.1 to 9.9	V	

<sup>\*2:</sup> The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

<sup>\*3:</sup> The power dissipation shown is the value at  $T_a = 70$ °C for the independent (unmounted) IC package.

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